Declaration and Power of Attorney for Patent Application

特許出願宣言書

Japanese Language Declaration

As a below named inventor, I hereby declare that:
My residence, post office address and citizenship are as stated below next to my name,
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled
SEMICONDUCTOR DEVICE AND PACKAGING
METHOD
the specification of which (check one)
is attached hereto.
was filed on as
Application Serial No.
and was amended on(if applicable)
I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.
I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).

Japanese Language Leclaration

私は、合衆国法典第35部第119条、第172条、又は第365条 に基づく下記の外国特許出願又は発明者証出願の外国優先権 利益を主張し、さらに優先権の主張に係わる基礎出願の出願 日前の出願日を有する外国特許出願又は発明者証出願を以下 に明記する: I hereby claim foreign priority benefits under Title 35, United States Code §119, §172 or §365 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior foreign applications 先の外国出願

			Priority claimed 優先権の主張	
225982/2000	Japan	26/7/2000	X	
(Number) (番 号)	(Country) (国 名)	(Day/Month/Year Filed) (出願の年月日)	Yes குற	No なし
(Number) (番 号)	(Country) (国 名)	(Day/Month/Year Filed) (出願の年月日)	Yes ,tp. n	No たし
(Number) (番号)	(Country) (国 名)	(Day/Month/Year Filed) (出願の年月日)	Yes あり	No なし
(番 号) [1]				
盘(Number) 雪(番 号)	(Country) (国 名)	(Day/Month/Year Filed) (出願の年月日)	Ye s க ர	No なし
ang (番 号) (番 号)				
(Number) (番 号)	(Country) (国 名)	(Day/Month/Year Filed) (出願の年月日)	Yes ຫຼ	No たし
gray				

私は、合衆国法典第35部第120条に基づく下記の合衆国特許出願の利益を主張し、本願の請求の範囲各項に記載の主題が合衆国法典第35部第112条第1項に規定の態様で先の合衆国出願 に関示されていない限度において、先の出願の出願日と本願の国内出願日又はPCT国際出顧日の間に公表された連邦規則法典第37部第1章第56条(a)項に記載の所要の情報を開示すべき義務を有することを認める。

I hereby claim the benefit of Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose any material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.)	(Filing Date)	(現 況)	(Status)
(出願番号)	(出顧日)	特許済み、係属中、放棄済み)	(patended, pending abandoned
(Application Serial No.)	(Filing Date)		(Status)
(出願番号)	(出顧日)	(特許済み、係属中、放棄済み)	(patended, pending abandoned

私は、ここに自己の知識に基づいて行った陳述がすべて真実であり、自己の有する情報及び信ずるところに従って行った陳述が真実であると信じ、更に故意に虚偽の陳述等を行った場合、合衆国法典第18部第1001条により、罰金もしくは禁固に処せられるか、又はこれらの刑が併科され、又はかかる故意による虚偽の陳述が本願ないし本願に対して付与される特許の有効性を損なうことがあることを認識して、以上の陳述を行ったことを宣言する。

I hereby declare that all statements made herein of my own knowledge are true; and further that all statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Japanese Language Declaration

委任状: 私は、下記発明者として、以下の代理人をここに 選任し、本願の手続きを遂行すること並びにこれに関する一 切の行為を特許商標局に対して行うことを委任する。 (代理人氏名及び登録番号を明記のこと) POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

I hereby appoint John H. Mion, Reg. No. 18,879; Donald E. Zinn, Reg. No. 19,046; Thomas J. Macpeak, Reg. No. 19,292; Robert J. Seas, Jr., Reg. No. 21,092; Darryl Mexic, Reg. No. 23,063; Robert V. Sloan, Reg. No. 22,775; Peter D. Olexy, Reg. No. 24,513; J. Frank Osha, Reg. No. 24,625; Waddell A. Biggart, Reg. No. 24,861; Robert G. McMorrow, Reg. No. 19,093; Louis Gubinsky, Reg. No. 24,835; Neil B. Siegel, Reg. No. 25,200; David J. Cushing, Reg. No. 28,703; John R. Inge, Reg. No. 26,916; Joseph J. Ruch, Jr., Reg. No. 26,577; Sheldon I. Landsman, Reg. No. 25,430; Richard C. Turner, Reg. No. 29,710; Howard L. Bernstein, Reg. No. 25,665; Alan J. Kasper, Reg. No. 25,426; Kenneth J. Burchfiel, Reg. No. 31,333; Gordon Kit, Reg. No. 30,764; Susan J. Mack, Reg. No. 30,951; Frank L. Bernstein, Reg. No. 31,484; Mark Boland, Reg. No. 32,197; William H. Mandir, Reg. No. 32,156; Scott M. Daniels, Reg. No. 32,562; Brian W. Hannon, Reg. No. 32,778; Abraham J. Rosner, Reg. No. 33,276; Bruce E. Kramer, Reg. No. 33,725; Paul F. Neils, Reg. No. 33,102; and Brett S. Sylvester, Reg. No. 32,765, my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and request that all correspondence about the application be addressed to SUGHRUE, MION, ZINN, MACPEAK & SEAS, PLLC, 2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037-3202.

書類の送付先:

Send Correspondence to:

SUGHRUE, MION, ZINN, MACPEAK & SEAS 2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037

直通電話運絡先: (名称及び電話	古香 号)	Direct Telephone Calls to: (name and	telepnone number)
1 3 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	(9)	00) 202 7060	-
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	(2)	02)293-7060	
1			
唯一の又は第一の発明者の氏名		Full name of sole or first inventor	
5 13 15 15 15 15 15 15 15 15 15 15 15 15 15		MICHIHIKO ICHINOSE	
同発明者の署名	目付	Inventor's signature	Date
2		Michipiko Dehinoso	7/11/2001
住所		Residence	
45 24 25 12 24 27 45 _ 3		Tokyo, Japan	
III		Citizenship	
Emergia M		Japanese	
郵便の宛先	- ¹⁹⁹ 郵便の宛先		
1-212		c/o NEC Corporation, 7-	l, Shiba 5-chome,
		Minato-ku, Tokyo Japan	
第二の共同発明者の氏名(該当する	場 合)	Full name of second joint inventor, if any	
同第二発明者の署名	日付	Second inventor's signature	Date
住所		Residence	
国籍		Citizenship	
郵便の宛先		Post office address	a shahana da sa

(第三又はそれ以降の共同発明者に対しても同様な情報 および署名を提供すること。) (Supply similar information and signature for third and subsequent joint inventors.)